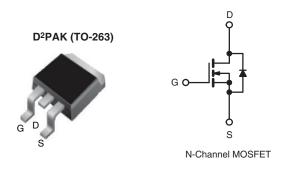
COMPLIANT

HALOGEN FREE



EL Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. at 25 °C (Ω)	V _{GS} = 10 V	0.171		
Q _g max. (nC)	74			
Q _{gs} (nC)	15			
Q _{gd} (nC)	15			
Configuration	Single			



FEATURES

- Reduced figure-of-merit (FOM) Ron x Qa
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Low gate charge (Q_a)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
 - Switch mode power supplies (SMPS)
 - Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION			
Package	D ² PAK (TO-263)		
Lead (Pb)-free and Halogen-free	SiHB22N60EL-GE3		

ABSOLUTE MAXIMUM RATINGS (T	C = 23 C, un	ess officiwis				
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V_{DS}	600	V	
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	- I _D	21	A	
	V _{GS} at 10 V	T _C = 100 °C		13		
Pulsed Drain Current ^a			I _{DM}	45		
Linear Derating Factor				1.8	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	286	mJ	
Maximum Power Dissipation			P_{D}	227	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	$V_{DS} = 0 V t$	V _{DS} = 0 V to 80 % V _{DS}		62)//	
Reverse Diode dV/dt d			dV/dt	22	V/ns	
Soldering Recommendations (Peak Temperature)	c for	for 10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.5 A.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, dI/dt = 100 A/ μ s, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.55	C/VV	

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		- 			-		•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	600	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I _D = 1 mA		0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		3	-	5	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	\	V _{GS} = ± 30 V		-	± 1	μA
		V _{DS} =	V _{DS} = 600 V, V _{GS} = 0 V		-	1	† ·
Zero Gate Voltage Drain Current	I _{DSS}		, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 11 A	-	0.171	0.197	Ω
Forward Transconductance	9fs	V _{DS} = 20 V, I _D = 11 A		-	6.5	-	S
Dynamic	-			l			
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	1690	-	pF
Output Capacitance	C _{oss}			-	95	-	
Reverse Transfer Capacitance	C _{rss}			-	5	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	85	-	
Effective Output Capacitance, Time Related ^b	$C_{o(tr)}$			-	296	-	
Total Gate Charge	Qg			-	37	74	
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		15	-	nC
Gate-Drain Charge	Q_{gd}			-	15	-	1
Turn-On Delay Time	t _{d(on)}		V _{DD} = 480 V, I _D = 11 A,		22	44	- ns
Rise Time	t _r				46	92	
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		-	27	54	
Fall Time	t _f			-	24	48	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	21	
Pulsed Diode Forward Current	I _{SM}			-	-	45	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	-		-	365	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 11 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	5.8	-	μC
Reverse Recovery Current	I _{RRM}			_	29	_	Α

Notes

- a. $C_{oss(er)}$ s a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .
- b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

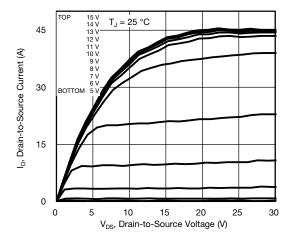


Fig. 1 - Typical Output Characteristics

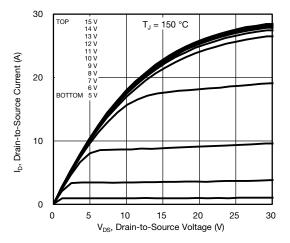


Fig. 2 - Typical Output Characteristics

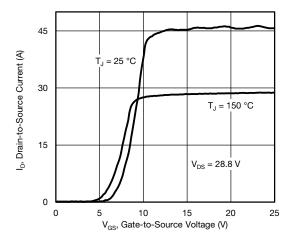


Fig. 3 - Typical Transfer Characteristics

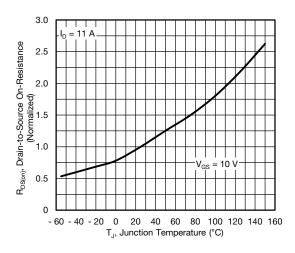


Fig. 4 - Normalized On-Resistance vs. Temperature

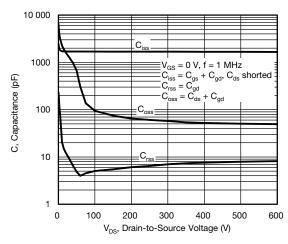


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

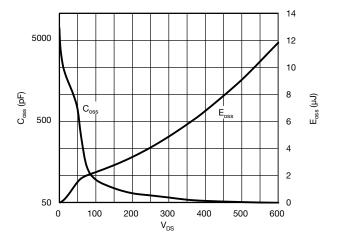


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



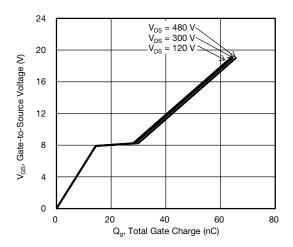


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

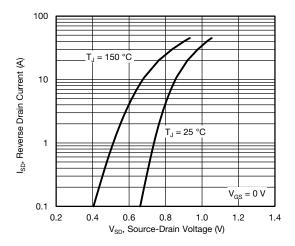


Fig. 8 - Typical Source-Drain Diode Forward Voltage

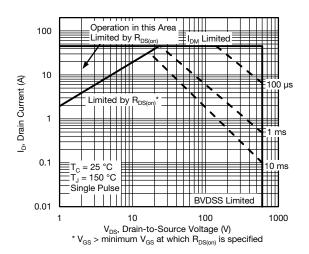


Fig. 9 - Maximum Safe Operating Area

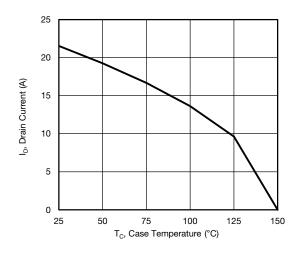


Fig. 10 - Maximum Drain Current vs. Case Temperature

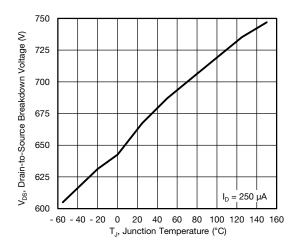


Fig. 11 - Temperature vs. Drain-to-Source Voltage



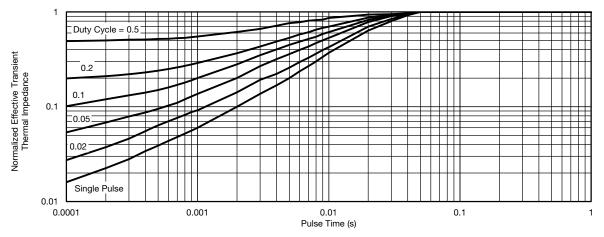


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

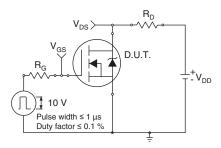


Fig. 13 - Switching Time Test Circuit

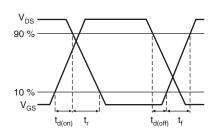


Fig. 14 - Switching Time Waveforms

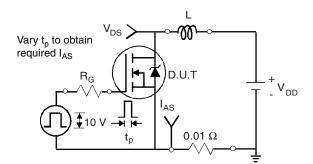


Fig. 15 - Unclamped Inductive Test Circuit

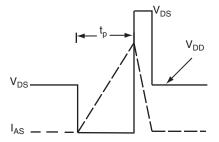


Fig. 16 - Unclamped Inductive Waveforms

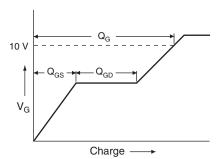


Fig. 17 - Basic Gate Charge Waveform

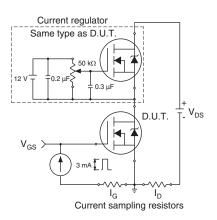
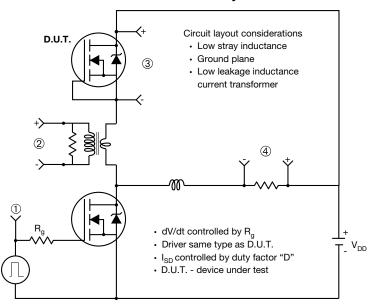


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



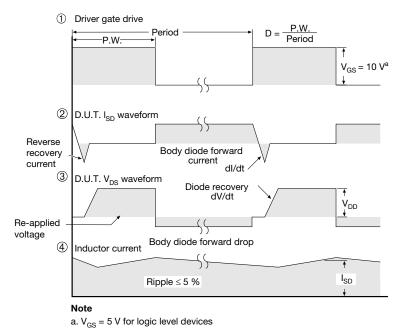


Fig. 19 - For N-Channel

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